

-46A, -30V P CHANNEL MOSFET

DESCRIPTION

SVT03110PL3 is a P channel enhancement mode power MOS field effect transistor which is produced using Silan's LVMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance and high avalanche breakdown tolerance.

This device is widely used in UPS, Power Management for Inverter Systems.

FEATURES

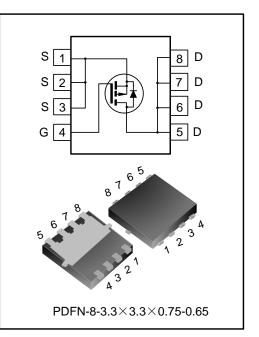
- -46A, -30V, R_{DS(on)(typ.)} =7.0mΩ@V_{GS}=-10V
- Low gate charge
- Low Crss
- Fast switching
- Improved dv/dt capability
- 100% avalanche tested
- Pb-free lead plating
- RoHS compliant

KEY PERFORMANCE PARAMETERS

Characteristics	Ratings	Unit
V _{DS}	-30	V
V _{GS(th)}	-1.0~-3.0	V
R _{DS(on),max}	11	mΩ
ID	-46	А
Q _{g.typ}	51	nC

ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVT03110PL3TR	PDFN-8-3.3x3.3x0.75-0.65	0311	Halogen free	Tape & Reel





ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, TJ=25°C)

Oberesteristics	Symbol Test conditions					
Characteristics			Min.	Тур.	Max.	Unit
Drain-Source Voltage	V _{DS}		-30			V
Gate-Source Voltage	V _{GS}		-20		20	V
		T _C =25°C			-46	А
Drain Current (Note 1)	ID	T _C =100°C			-29	А
Drain Current Pulsed (Note 2)	I _{DM}	T _C =25°C			-184	А
Power Dissipation (Note 3)	PD	T _C =25°C			35	W
Single Pulsed Avalanche	L	L=0.1mH, V_{DD} =-24V, R_G =25 Ω ,			405.0	
Energy	E _{AS}	starting temperature $T_J=25^{\circ}C$			105.8	mJ
Single Pulsed Current	I _{AS}				46	А
Operation Junction	т		55		150	° C
Temperature Range	TJ		-55		150	°C
Storage Temperature Range	T _{stg}		-55		150	°C

THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Rating			Unit
Gilaracteristics	Characteristics Symbol Test conditions		Min.	Тур.	Max.	Onit
Thermal Resistance,	Б				3.57	°C/W
Junction-case, Bottom	R _{θJC}				3.57	-0/00
Thermal Resistance,	Б				59	0000
Junction-ambient	R _{θJA}				29	°C/W
Soldering Temperature	т				260	° C
(SMD)	T _{sold}	Reflow soldering: 10 ± 1 sec, 3times			260	°C

ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, TJ=25°C)

Static characteristics

Characteristics	Sumbol	Test conditions		Unit			
Characteristics	Symbol	Symbol Test conditions		Тур.	Max.	Unit	
Drain-source Breakdown	BVDSS		-30			V	
Voltage	DVDSS	V _{GS} =0V, I _D =-250µA				V	
Drain-source Leakage		V _{DS} =-30V, V _{GS} =0V, T _J =25°C			-1.0		
Current	I _{DSS}	V _{DS} =-30V, V _{GS} =0V, T _J =125°C		-1.5		μA	
Gate-source Leakage		V _{GS} =±20V, V _{DS} =0V			±100	nA	
Current	I _{GSS}						
Gate Threshold Voltage	V _{GS(th)}	$V_{GS}=V_{DS}$, $I_{D}=-250\mu A$	-1.0		-3.0	V	
Static Drain-source	D	V _{GS} =-10V, I _D =-15A		7.0	11	~ 0	
On State Resistance	$R_{DS(on)}$	V _{GS} =-4.5V, I _D =-10A		10	13.8	mΩ	
Gate Resistance	R _g	f=1MHz		3.2		Ω	



Dynamic characteristics

Characteristics	Symbol	Test conditions			Ratings		
Characteristics			Min.	Тур.	Max.	Unit	
Input Capacitance	C _{iss}			2419			
Output Capacitance	Coss	f=1MHz, V _{GS} =0V, V _{DS} =-15V		398		ъĘ	
Reverse Transfer Capacitance	C _{rss}	1=Πνίμζ, V _{GS} =0V, V _{DS} =-15V		357		pF	
Turn-on Delay Time	t _{d(on)}			9.3			
Turn-on Rise Time	tr	V _{DD} =-20V, V _{GS} =-10V, R _G =6.0Ω, I _D =-11.5A		39		20	
Turn-off Delay Time	t _{d(off)}	(Notes 4, 5)		72		ns	
Turn-off Fall Time	t _f	(Notes 4, 5)		46			
Total Gate Charge	Qg			51			
Gate-source Charge	Q _{gs}	V _{DD} =-15V, V _{GS} =-10V, I _D =-11.5A		9.4		nC	
Gate-drain Charge	Q _{gd}	(Notes 4, 5)		11			
Gate-plateau Voltage	V _{plateau}			3.4		V	

Reverse diode characteristics

Characteristics	Symbol Test conditions			Ratings			Unit	
Characteristics	Symbol	rest conditions		in.	Тур.	Max.	Unit	
Continuous Source	I	T 25%C late and Deverse D N				-46		
Current	I _S	T _C =25°C, Integral Reverse P-N Junction Diode in the MOSFET				-40	А	
Pulsed Source Current	I _{S,pulse}	Sunction Diode in the MOSFET				-184		
Diode Forward Voltage	V_{SD}	I _S =-1.0A, V _{GS} =0V				-1.4	V	
Reverse Recovery Time	Trr	I _S =-11.5A, V _{GS} =0V, V _R =30V			19		ns	
Reverse Recovery	0		1)		11		nC	
Charge	Q _{rr}	dl _F /dt=100A/µs (Note	4)				nc	

Notes:

1. The rated value only refers to the maximum absolute value at the case temperature of 25°C in the specification. If the case temperature is higher than 25°C, it should be derated according to the actual environmental conditions;

2. Pulse time 5µs, pulse width is limited by the maximum junction temperature;

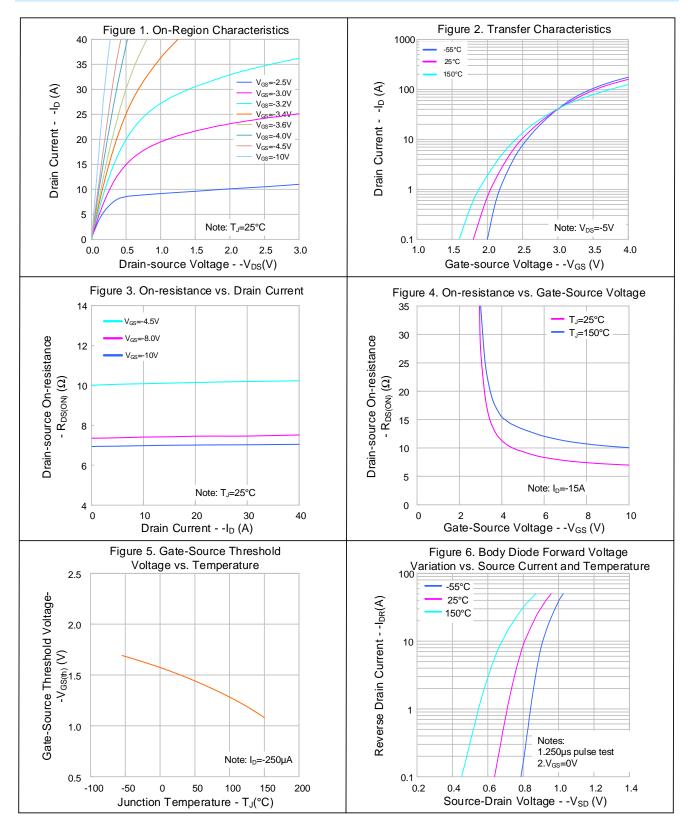
3. The dissipation power will change with temperature, derating above 25°C: 0.28W/°C;

4. Pulse Test: Pulse width ≤300µs, Duty cycle≤2%;

5. Essentially independent of operating temperature.

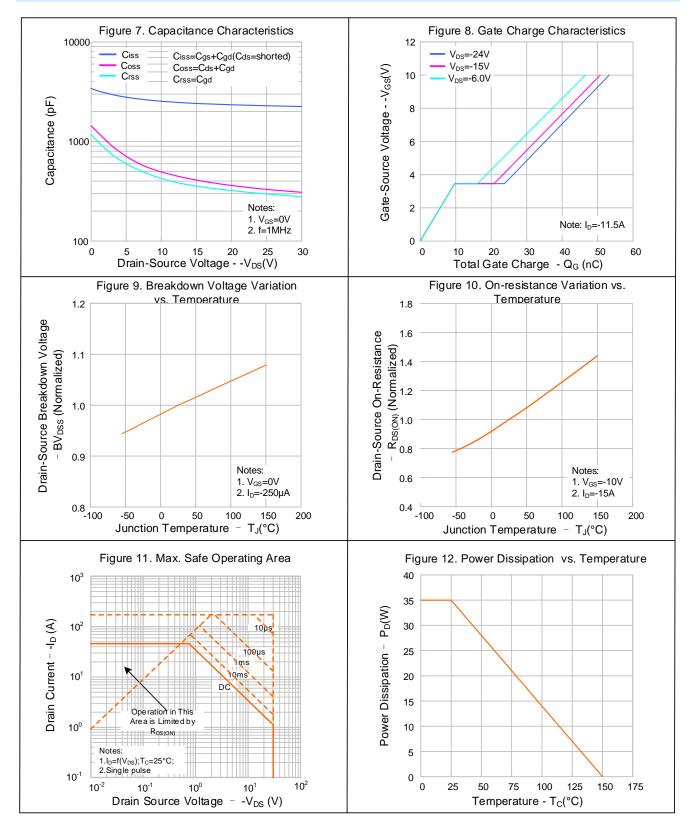


TYPICAL CHARACTERISTICS



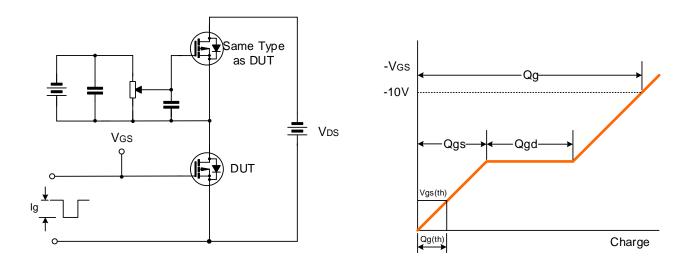


TYPICAL CHARACTERISTICS (CONTINUED)



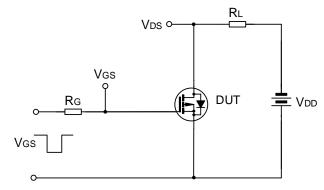


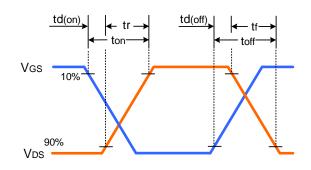
TYPICAL TEST CIRCUIT



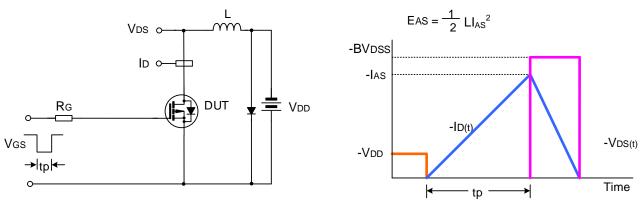
Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveform



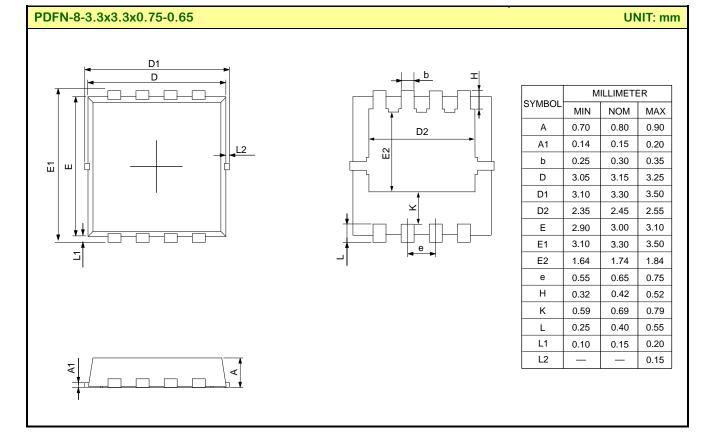


Unclamped Inductive Switching Test Circuit & Waveform





PACKAGE OUTLINE





MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.



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Part No	.: SVT03110PL3		Document Type:	Datasheet
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Rev.:		1.1		
Revision	n Histo	ry:		
1. Delete wave soldering condition		e wave soldering condition		
2.	Upda	te the typical test circuit		
3.	3. Update the important notice			
Rev.: 1.0		1.0		
Revisio	n Histo	ry:		
1.	First	release		